## CMOS IC 4.5K-byte FROM and 128-byte RAM integrated 8-bit 1-chip Microcontroller



## Overview

The LC87F0N04A is an 8-bit microcomputer that, integrates on a single chip a number of hardware features such as 4.5K-byte flash ROM, 128-byte RAM, 16-bit timers/counters, a 16-bit timer, an asynchronous/synchronous SIO interface, motor control 10-bit PWM, two Analog Comparators, a 6-channel AD converter, a system clock frequency divider, an internal reset and an interrupt feature.

## Features

- ■Flash ROM
  - 4608 × 8 bits (4096 + 512-byte)
  - Capable of On-board programming with wide range (2.8 to 5.5V) of voltage source.
  - Block-erasable in 128 byte units
  - Writable in 2-byte units

### ■RAM

- 128 × 9 bits
- ■Package Form
  - SSOP16 (225mil) : Lead-/Halogen-free type

## Package Dimensions

unit : mm (typ)



\* This product is licensed from Silicon Storage Technology, Inc. (USA).

■Minimum Bus Cycle

• 100.0ns (10MHz at V<sub>DD</sub>=2.8V to 5.5V)

Note: The bus cycle time here refers to the ROM read speed.

#### Ports

- Normal withstand voltage I/O ports
- Ports I/O direction can be designated in 1 bit units 12(P00 to P03, P1n)
- Reset pin
   1 (RES)
   On-chip Debugger pin
   1 (OWP0)
- Power pins 2 (V<sub>SS</sub>, V<sub>DD</sub>)
- ■Timers
  - Timer 0: 16-bit timer/counter with a capture register.
    - Mode 0: 8-bit timer with an 8-bit programmable prescaler (with an 8-bit capture register) × 2 channels Mode 1: 8-bit timer with an 8-bit programmable prescaler (with an 8-bit capture register)
      - + 8-bit counter (with an 8-bit capture register)
    - Mode 2: 16-bit timer with an 8-bit programmable prescaler (with a 16-bit capture register)
    - Mode 3: 16-bit counter (with a 16-bit capture register)
  - Timer 1: 16-bit timer/counter that supports PWM/toggle outputs
    - Mode 0: 8-bit timer with an 8-bit prescaler (with toggle outputs)  $\times$  2 channels
      - Mode 1: 8-bit PWM with an 8-bit prescaler  $\times$  2 channels
      - Mode 2: 16-bit timer/counter with an 8-bit prescaler (with toggle outputs) (toggle outputs also possible from the lower-order 8 bits)
      - Mode 3: 16-bit timer with an 8-bit prescaler (with toggle outputs)
        - (The lower-order 8 bits can be used as PWM.)
  - Base timer
    - 1) The clock is selectable from system clock, and timer 0 prescaler output.
    - 2) Interrupts are programmable in 5 different time schemes

#### ■SIO

- SIO1: 8-bit asynchronous/synchronous serial interface
  - Mode 0: Synchronous 8-bit serial I/O (2- or 3-wire configuration, 2 to 512 tCYC transfer clocks)
  - Mode 1: Asynchronous serial I/O (half-duplex, 8 data bits, 1 stop bit, 8 to 2048 tCYC baudrates)
  - Mode 2: Bus mode 1 (start bit, 8 data bits, 2 to 512 tCYC transfer clocks)
  - Mode 3: Bus mode 2 (start detect, 8 data bits, stop detect)
- **AD** Converter: 10 bits/8 bits  $\times$  6 channels
  - 10/8 bits AD converter resolution selectable
  - Auto start function (It links an interrupt factor of Motor control PWM)
- Remote Control Receiver Circuit (sharing pins with P11, INT3)
- Noise rejection function (noise filter time constant selectable from 1 tCYC, 32 tCYC, and 128 tCYC)
- Clock Output Function
  - Can generate clock outputs with a frequency of 1/1, 1/2, 1/4, 1/8, 1/16, 1/32, 1/64 of the source clock selected as the system clock.

#### ■Analog Comparator × 2 channels

- Analog comparator Interrupt.
- Analog comparator reference selectable (External input / Programmable on-chip voltage reference). The voltage reference has 2 ranges with 16-level voltage levels in each range.
- $\begin{aligned} & \text{Rang1: CMP1vref1} = (\text{CMP1vref-Register} < 3:0> + 1 \ )/16 \times \text{V}_{\text{DD}} \times 0.64 \\ & \text{CMP2vref2} = (\text{CMP2vref-Register} < 3:0> + 1 \ )/16 \times \text{V}_{\text{DD}} \times 0.64 \\ & \text{Rang2: CMP1vref1} = (\text{CMP1vref-Register} < 3:0> + 1 \ )/64 \times \text{V}_{\text{DD}} \times 0.64 \\ & \text{CMP2vref2} = (\text{CMP2vref-Register} < 3:0> + 1 \ )/64 \times \text{V}_{\text{DD}} \times 0.64 \end{aligned}$
- ■MCPWM2: Motor control 10bits PWM with Full-Bridge
  - Dead time is programmable.
  - Forced stop is possible by the output of the analog comparator and the INT terminals.
  - Edge-aligned / center-aligned selectable.

■Watchdog Timer

- Can generate the internal reset signal on a timer overflow monitored by the WDT-dedicated low-speed RC oscillation clock (30kHz).
- Allows selection of continue, stop, or hold mode operation of the counter on entry into the HALT/HOLD mode.

#### ■Interrupts

- 14 sources, 9 vector addresses
- 1) Provides three levels (low (L), high (H), and highest (X)) of multiplex interrupt control. Any interrupt requests of the level equal to or lower than the current interrupt are not accepted.
- 2) When interrupt requests to two or more vector addresses occur at the same time, the interrupt of the highest level takes precedence over the other interrupts. For interrupts of the same level, the interrupt into the smallest vector address takes precedence.

No.	Vector Address	Level	Interrupt Source
1	00003H	X or L	INTO
2	0000BH	X or L	INT1
3	00013H	H or L	INT2/T0L
4	0001BH	H or L	INT3/base timer
5	00023H	H or L	тон
6	0002BH	H or L	T1L/T1H
7	00033H	H or L	-
8	0003BH	H or L	SIO1/PWM
9	00043H	H or L	ADC
10	0004BH	H or L	CMP1/CMP2

• Priority levels X > H > L

• Of interrupts of the same level, the one with the smallest vector address takes precedence.

■Subroutine Stack Levels: 64levels (The stack is allocated in RAM.)

#### ■High-speed Multiplication/Division Instructions

- 16 bits  $\times$  8 bits (5 tCYC execution time)
- 24 bits  $\times$  16 bits (12 tCYC execution time)
- 16 bits ÷ 8 bits (8 tCYC execution time)
- 24 bits  $\div$  16 bits (12 tCYC execution time)

■Oscillation Circuits

Internal oscillation circuits

Medium-speed RC oscillation circuit :	For system clock (1MHz)
High-speed RC oscillation circuit :	For system clock (10MHz)
Low-speed RC oscillation circuit :	For watch dog timer (30kHz)

- System Clock Divider Function
  - Can run on low current.
  - The minimum instruction cycle selectable from 300ns, 600ns, 1.2µs, 2.4µs, 4.8µs, 9.6µs, 19.2µs, 38.4µs, and 76.8µs (at a main clock rate of 10MHz).

#### ■Internal Reset Function

- Power-on reset (POR) function
  - 1) POR reset is generated only at power-on time.
  - 2) The POR release level can be selected from 8 levels (1.67V, 1.97V, 2.07V, 2.37V, 2.57V, 2.87V, 3.86V, and 4.35V) through option configuration.
- Low-voltage detection reset (LVD) function
  - 1) LVD and POR functions are combined to generate resets when power is turned on and when power voltage falls below a certain level.
  - 2) The use / disuse of the LVD function and the low voltage threshold level (7 levels: 1.91V, 2.01V, 2.31V, 2.51V, 2.81V, 3.79V, 4.28V).

## ■Standby Function

- HALT mode: Halts instruction execution while allowing the peripheral circuits to continue operation.
  - 1) Oscillation is not halted automatically.
  - 2) There are three ways of resetting the HALT mode.
    - (1) Setting the reset pin to the low level
    - (2) System resetting by watchdog timer or low-voltage detection
    - (3) Occurrence of an interrupt
- HOLD mode: Suspends instruction execution and the operation of the peripheral circuits.
  - 1) The RC oscillators automatically stop operation.
  - 2) There are four ways of resetting the HOLD mode.
    - (1) Setting the reset pin to the lower level.
    - (2) System resetting by watchdog timer or low-voltage detection
    - (3) Having an interrupt source established at either INT0, INT1, INT2
      - \* INT0 and INT1 HOLD mode reset is available only when level detection is set.

■On-chip Debugger

• Supports software debugging with the IC mounted on the target board.

■Data Security Function (flash versions only)

• Protects the program data stored in flash memory from unauthorized read or copy. Note: This data security function does not necessarily provide absolute data security.

#### ■Development Tools

• On-chip-debugger : TCB87 TypeC + LC87F0N04A

#### ■Programming Boards

Package	Programming boards
SSOP16(225mil)	W87F0NS

#### Flash ROM Programmer

Maker		Model	Supported version	Device	
	Single	AF9709/AF9709B/AF9709C Rev 03.28 or later		87F008SU	
	Programmer	(Including Ando Electric Co., Ltd. models)	Rev 03.28 or later	(3B247)	
Flash Support Group, Inc.		AF9723/AF9723B(Main body)			
(FSG)	Gang	(Including Ando Electric Co., Ltd. models)	-	-	
	Programmer	AF9833(Unit)			
		(Including Ando Electric Co., Ltd. models)	-	-	
	Single/Gang	SKK / SKK Type B	Application Version		
	Programmer	(SanyoFWS)	1.07 or later		
	Gang	SKK-4G	Chip Data Version		
Sanyo	Programmer	(SanyoFWS)	2.40 or later	LC87F0N04	
Saliyo			Application Version	LC07FUN04	
	In-circuit/Gang	SKK-DBG Type C	1.07 or later		
	Programmer	(SanyoFWS)	Chip Data Version		
			2.40 or later		

For information about AF-Series:

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## **Pin Assignment**



Top view

### SANYO: SSOP16(225mil) "Lead-/Halogen-free Type"

SSOP16	NAME
9	P14/SI1/SB1/INT0/T0LCP
10	P15/SCK1/INT1/T0HCP/CMP2O
11	P16/AN4/T1PWML/CMP2IB(+)
12	P17/AN5/T1PWMH/CMP2IA(-)/BUZ
13	P00/MP2OT0
14	P01/MP2OT0
15	P02/MP2OT1/CKO
16	P03/MP2OT1

SSOP16	NAME
1	RES
2	V <sub>SS</sub> 1
3	OWP0
4	V <sub>DD</sub> 1
5	P10/AN0/INT2/T0LCP/T0IN
6	P11/AN1/INT3/T0HCP/T0IN/CMP1IB(+)
7	P12/AN2/CMP1IA(-)
8	P13/SO1/AN3/CMP1O

## System Block Diagram



# **Pin Description**

Pin Name	I/O			Desc	ription			Option	
V <sub>SS</sub> 1	-	- power supply pi	er supply pin						
V <sub>DD</sub> 1	-	+ power supply p	n					No	
Port 0	I/O	• 4-bit I/O port						Yes	
P00 to P03	1	• I/O specifiable in	n 1 bit units						
		Pull-up resistors	can be turned o	on and off in 1 bit	units.				
		<ul> <li>Pin functions</li> </ul>							
		P00: MP2OT0(F	• •						
		P01: MP2OT0 (	PWM output)						
		·		stem clock outp	ut				
		P03: MP2OT1 (	PWM output)						
Port 1	I/O	<ul> <li>8-bit I/O port</li> </ul>	8-bit I/O port						
P10 to P17		<ul> <li>I/O specifiable in</li> </ul>	n 1 bit units						
		<ul> <li>Pull-up resistors</li> </ul>	can be turned o	on and off in 1 bit	units.				
		Pin functions							
		P10: AN0(AD converter input) / INT2 input / HOLD reset input /							
		timer 0 event input / timer 0L capture input							
		P11: AN1(AD converter input) / INT3 input (with noise filter) /							
		timer 0 event input / timer 0H capture input / CMP1(+) input							
		P12: AN2(AD co							
		P13: SIO1 data output / AN3(AD converter input) / CMP1 output							
		P14: SIO1 data input / bus I/O / INT0 input / HOLD reset input / timer 0L capture input							
		P15: SIO1 clock I/O / INT1 input / HOLD reset input / timer 0H capture input / CMP2 output							
		P16: Timer 1PWML output / CMP2(+) input / AN4(AD converter input) P17: Timer 1PWMH output / beeper output / CMP2(-) input / AN5(AD converter input)							
		P17: Timer 1PW	/MH output / bee	eper output / CM	<sup>2</sup> 2(-) input / AN5	AD converter inp	out)		
		Interrupt acknowl	edae type						
			0 71		Rising &				
			Rising	Falling	Falling	H level	L level		
		INT0	enable	enable	disable	enable	enable		
		INT1	enable	enable	disable	enable	enable		
		INT2	enable	enable	enable	disable	disable		
		INT3	enable	enable	enable	disable	disable		
								ļ	
OWP0	I/O	On-chip debugge	r (exclusive pin)					No	
RES	I/O	External reset Inp	ut / internal rese	t output				No	

## **Port Output Types**

The table below lists the types of port outputs and the presence/absence of a pull-up resistor. Data can be read into any input port even if it is in the output mode.

Port Name	Option selected in units of	Option type	Output type	Pull-up resistor
P00 to P03	1 bit	1	CMOS	Programmable
P10 to P17		2	Nch-open drain	Programmable

## **User Option Table**

Option Name	Option to be Applied on	Flash-ROM Version	Option Selected in Units of	Option Selection
Port output type	P00 to P03	0	1 bit	CMOS
				Nch-open drain
	P10 to P17	0	1 bit	CMOS
				Nch-open drain
Low-voltage detection	Detect function	0	-	Enable:Use
reset function				Disable:Not Used
	Detect level	0	-	7-level
Power-on reset	Power-On reset level	0	-	8-level
function				

## **Recommended Unused Pin Connections**

Dert News	Recommended Unused Pin Connections				
Port Name	Board	Software			
P00 to P03	Open	Output low			
P10 to P17	Open	Output low			

## **On-chip Debugger Pin Connection Requirements**

Install and connect a limiting resistor  $(100\Omega)$  to the on-chip debugger dedicated pin (OWP0) on the user board and pull the pin down  $(100k\Omega)$ . It is recommended to install a dedicated connector to accept the cable to the debugging tool (TCB87 Type C). The connector must accommodate three lines, i.e., VSS1, OWP0, and VDD1.



## Absolute Maximum Ratings at $Ta = 25^{\circ}C$ , $V_{SS}1 = 0V$

	Parameter	Symbol	Pin/Remarks	Conditions			Specif	ication	
	Parameter	Symbol	Pin/Remarks	Conditions	V <sub>DD</sub> [V]	min	typ	max	unit
	aximum supply Itage	V <sub>DD</sub> max	V <sub>DD</sub> 1			-0.3		+6.5	
Inp	out voltage	VI	RES		-0.3 V <sub>DD</sub> +0.3		V		
	out/output Itage	V <sub>IO</sub>	Ports 0, 1			-0.3		V <sub>DD</sub> +0.3	
current	Peak output current	IOPH(1)	Ports 0, 1	CMOS output select Per 1 applicable pin		-10			
High level output current	Mean output current (Note 1-1)	IOMH(1)	Ports 0, 1	CMOS output select Per 1 applicable pin		-7.5			
High le	Total output current	ΣIOAH(1)	Ports 0	Total of all applicable pins		-25			
		ΣIOAH(2)	Ports 1	Total of all applicable pins		-25			
urrent	Peak output current	IOPL(1)	Ports0, 1	Per 1 applicable pin				20	mA
Low level output current	Mean output current (Note 1-1)	IOML(1)	Ports 0, 1	Per 1 applicable pin				15	
w lev	Total output	$\Sigma IOAL(1)$	Ports 0	Total of all applicable pins				45	
Lo	current	ΣIOAL(2)	Ports 1	Total of all applicable pins				45	
Po	wer dissipation	Pdmax	SSOP16	Ta=-40 to +85°C Package with thermal resistance board (Note 1-2)				238	mW
•	perating ambient	Topr				-40		+85	°C
	orage ambient nperature	Tstg				-55		+125	ç

Note 1-1: The mean output current is a mean value measured over 100ms.

Note 1-2: SEMI standards thermal resistance board (size: 76.1×114.3×1.6tmm, glass epoxy) is used.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Deservator	Querra la cl	Dia (Dia se a sha	Open dition of			Specif	ication	
Parameter	Symbol	Pin/Remarks	Conditions	V <sub>DD</sub> [V]	min	typ	max	unit
Operating supply voltage	V <sub>DD</sub> (1)	V <sub>DD</sub> 1	$0.291 \mu s \leq tCYC \leq 200 \mu s$		2.8		5.5	
Memory sustaining supply voltage	V <sub>HD</sub>	V <sub>DD</sub> 1	RAM and register contents sustained in HOLD mode.		2.0			
High level input voltage	V <sub>IH</sub> (1)	Ports 1		2.8 to 5.5	0.3V <sub>DD</sub> +0.7		V <sub>DD</sub>	
	V <sub>IH</sub> (2)	Ports 0		2.8 to 5.5	0.3V <sub>DD</sub> +0.7		V <sub>DD</sub>	v
	V <sub>IH</sub> (3)	RES		2.8 to 5.5	0.75V <sub>DD</sub>		V <sub>DD</sub>	v
Low level input voltage	V <sub>IL</sub> (1)	Ports 1		4.0 to 5.5	V <sub>SS</sub>		0.1V <sub>DD</sub> +0.4	
				2.8 to 4.0	VSS		0.2V <sub>DD</sub>	
	V <sub>IL</sub> (2)	Ports 0		4.0 to 5.5	V <sub>SS</sub>		0.15V <sub>DD</sub> +0.4	
				2.8 to 4.0	V <sub>SS</sub>		0.2V <sub>DD</sub>	
	V <sub>IL</sub> (3)	RES		2.8 to 5.5	V <sub>SS</sub>		0.25V <sub>DD</sub>	
Instruction cycle time (Note 2-1)	tCYC			2.8 to 5.5	0.291		200	μs
Oscillation frequency	FmMRC(1)		Internal High-speed RC oscillation. (Note 2-2)	2.8 to 5.5	9.7	10.0	10.3	MHz
range	FmMRC(2)		Internal High-speed RC oscillation. Ta=0°C to 85°C (Note 2-2)	2.8 to 5.5	9.75	10.0	10.25	MHz
-	FmRC		Internal Medium-speed RC oscillation	2.8 to 5.5	0.5	1.0	2.0	MHz
	FmSRC		Internal Slow-speed RC oscillation for watchdog timer.	2.8 to 5.5	15	30	60	kHz

## Allowable Operating Conditions at $Ta = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{SS}1 = 0V$

Note 2-1: Relationship between tCYC and oscillation frequency is 3/FmMRC at a division ratio of 1/1 and 6/FmMRC at a division ratio of 1/2.

Note 2-2: When switching the system clock, allow an oscillation stabilization time of 100µs or longer after the High-speed RC oscillator circuit transmits from the "oscillation stopped" to "oscillation enabled" state.

Deveryor	O week al	Die /Dementer	O an althing a			Specifica	ation	
Parameter	Symbol	Pin/Remarks	Conditions	V <sub>DD</sub> [V]	min	typ	max	unit
High level input current	I <sub>IH</sub> (1)	Ports 0, 1 RES	Output disabled Pull-up resistor off VIN=VDD (Including output Tr's off leakage	2.8 to 5.5			1	
Low level input current	I <sub>IL</sub> (1)	Ports 0, 1 RES	current) Output disabled Pull-up resistor off VIN=VSS (Including output Tr's off leakage current)	2.8 to 5.5	-1			μA
High level output	V <sub>OH</sub> (1)	Ports 0, 1	I <sub>OH</sub> =-1mA	4.5 to 5.5	V <sub>DD</sub> -1			
voltage	V <sub>OH</sub> (2)		I <sub>OH</sub> =-0.35mA	2.8 to 5.5	V <sub>DD</sub> -0.4			
	V <sub>OH</sub> (3)	Port0	I <sub>OH</sub> =-6mA	4.5 to 5.5	V <sub>DD</sub> -1			
	V <sub>OH</sub> (4)	(Note 3-1)	I <sub>OH</sub> =-1.4mA	2.8 to 5.5	V <sub>DD</sub> -0.4			V
Low level output	V <sub>OL</sub> (1)	Ports 0, 1	I <sub>OL</sub> =10mA	4.5 to 5.5			1.5	1
voltage	V <sub>OL</sub> (2)		I <sub>OL</sub> =1.4mA	2.8 to 5.5			0.4	
Pull-up resistance	Rpu(1)	Ports 0, 1	V <sub>OH</sub> =0.9V <sub>DD</sub>	4.5 to 5.5	15	35	80	
	Rpu(2)			2.8 to 4.5	18	50	230	kΩ
Hysteresis voltage	VHYS	P10(INT2), P11(INT3), P14,P15, RES		2.8 to 5.5		0.1 V <sub>DD</sub>		v
Pin capacitance	СР	All pins	For pins other than that under test: VIN=VSS f=1MHz Ta=25°C	2.8 to 5.5		10		pF

## **Electrical Characteristics** at $Ta = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{SS}1 = 0V$

Note 3-1: When Ports0 selected MCPWM2.

		Damanatan	Querra ha a l	Pin/	Conditions			Spec	ification	
	I	Parameter	Symbol	Remarks	Conditions	V <sub>DD</sub> [V]	min	typ	max	unit
	×	Frequency	tSCK(3)	SCK1(P15)	• See Fig. 4.		2			
	Input clock	Low level pulse width	tSCKL(3)			2.8 to 5.5	1			
Serial clock	In	High level pulse width	tSCKH(3)				1			tCYC
Serial	Ś	Frequency	tSCK(4)	SCK1(P15)	CMOS output selected     See Fig. 4.		2			
	Output clock	Low level pulse width	tSCKL(4)			2.8 to 5.5		1/2		tSCK
	õ	High level pulse width	tSCKH(4)					1/2		ISCK
Serial input	Da	ata setup time	tsDI(2)	SB1(P14), SI1(P14)	<ul> <li>Must be specified with respect to rising edge of SIOCLK.</li> </ul>		0.05			
Serial	Da	ata hold time	thDI(2)		• See Fig. 4.	2.8 to 5.5	0.05			
Serial output	Οι	utput delay time	tdD0(4)	SO1(P13), SB1(P14)	<ul> <li>Must be specified with respect to falling edge of SIOCLK.</li> <li>Must be specified as the time to the beginning of output state change in open drain output mode.</li> <li>See Fig. 4.</li> </ul>	2.8 to 5.5			(1/2)tCYC +0.08	μs

Note 4: These specifications are theoretical values. Add margin depending on its use.

## **Pulse Input Conditions** at $Ta = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{SS}1 = 0V$

Demonster	Querrahaal	Dia (Derserte	O and it is an			Speci	fication	
Parameter	Symbol	Pin/Remarks	Conditions	V <sub>DD</sub> [V]	min	typ	max	unit
High/low level pulse width	tPIH(1) tPIL(1)	INT0(P14), INT1(P15), INT2(P10)	<ul> <li>Interrupt source flag can be set.</li> <li>Event inputs for timer 0 or 1 are enabled.</li> </ul>	2.8 to 5.5	1			
	tPIH(2) tPIL(2)	INT3(P11) when noise filter time constant is 1/1	<ul> <li>Interrupt source flag can be set.</li> <li>Event inputs for timer 0 are enabled.</li> </ul>	2.8 to 5.5	2			101/0
	tPIH(3) tPIL(3)	INT3(P11) when noise filter time constant is 1/32	<ul> <li>Interrupt source flag can be set.</li> <li>Event inputs for timer 0 are enabled.</li> </ul>	2.8 to 5.5	64			tCYC
	tPIH(4) tPIL(4)	INT3(P11) when noise filter time constant is 1/128	<ul> <li>Interrupt source flag can be set.</li> <li>Event inputs for timer 0 are enabled.</li> </ul>	2.8 to 5.5	256			
	tPIL(5)	RES	<ul> <li>Resetting is enabled.</li> </ul>	2.8 to 5.5	200			μs

## AD Converter Characteristics at $V_{SS}1 = 0V$

#### <10bits AD Converter Mode/Ta = $-40^{\circ}$ C to $+85^{\circ}$ C >

Damanatan	Ormshall	Pin/Remarks	Oraditions			Specifi	cation	
Parameter	Symbol	FIII/Remarks	Conditions	V <sub>DD</sub> [V]	min	typ	max	unit
Resolution	N	AN0(P10) to		2.8 to 5.5		10		bit
Absolute accuracy	ET	AN3(P13) AN4(P16)	(Note 6-1)	2.8 to 5.5			±4	LSB
Conversion time	TCAD	AN5(P17)	See Conversion time calculation	4.0 to 5.5	7.8		65.6	
			formulas. (Note 6-2)	2.8 to 5.5	15		65.6	μs
Analog input voltage range	VAIN			2.8 to 5.5	V <sub>SS</sub>		V <sub>DD</sub>	V
Analog port	IAINH		VAIN=V <sub>DD</sub>	2.8 to 5.5			1	
input current	IAINL		VAIN=V <sub>SS</sub>	2.8 to 5.5	-1			μA

#### <8bits AD Converter Mode/Ta = $-40^{\circ}$ C to $+85^{\circ}$ C >

	0					Specifi	cation	
Parameter	Symbol	Pin/Remarks	Conditions	V <sub>DD</sub> [V]	min	typ	max	unit
Resolution	Ν	AN0(P10) to		2.8 to 5.5		8		bit
Absolute accuracy	ET	AN3(P13) AN4(P16)	(Note 6-1)	2.8 to 5.5			±1.5	LSB
Conversion time	TCAD	AN5(P17)	See Conversion time calculation	4.0 to 5.5	2.85		25.0	
			formulas. (Note 6-2)	2.8 to 5.5	5.5		25.0	μS
Analog input voltage range	VAIN			2.8 to 5.5	V <sub>SS</sub>		V <sub>DD</sub>	V
Analog port	IAINH		VAIN=V <sub>DD</sub>	2.8 to 5.5			1	
input current	IAINL	<u> </u>	VAIN=V <sub>SS</sub>	2.8 to 5.5	-1			μA

Conversion time calculation formulas:

10bits AD Converter Mode: TCAD(Conversion time) =  $((40/(AD \text{ division ratio}))+2)\times(1/3)\times tCYC$ 

8bits AD Converter Mode: TCAD(Conversion time) =  $((28/(AD \text{ division ratio}))+2)\times(1/3)\times tCYC$ 

External oscillation	Operating supply voltage range	System division ratio	Cycle time	AD divis (AD		AD conversion time (TCAD)		
(FmMRC)	(V <sub>DD</sub> )	(SYSDIV)	(tCYC)	10bit AD	8bit AD	10bit AD	8bit AD	
401411	4.0V to 5.5V	1/1	300ns	1/2	1/1	8.5µs	2.9µs	
10MHz	2.8V to 5.5V	1/1	300ns	1/4	1/2	17µs	5.8µs	

Note 6-1: The quantization error (±1/2LSB) must be excluded from the absolute accuracy. The absolute accuracy must be measured in the microcontroller's state in which no I/O operations occur at the pins adjacent to the analog input channel.

Note 6-2: The conversion time refers to the period from the time an instruction for starting a conversion process till the time the conversion results register(s) are loaded with a complete digital conversion value corresponding to the analog input value.

The conversion time is 2 times the normal-time conversion time when:

• The first AD conversion is performed in the 10-bit AD conversion mode after a system reset.

• The first AD conversion is performed after the AD conversion mode is switched from 8-bit to 10-bit conversion mode.

## **Power-on Reset (POR) Characteristics** at Ta = -40 °C to +85 °C, $V_{SS}1 = 0V$

						Specif	ication	
Parameter	Symbol	Pin/Remarks	Conditions	Option selected voltage	min	typ	max	unit
POR release	PORRL		Select from option.	1.67V	1.55	1.67	1.79	
voltage			(Note 7-1)	1.97V	1.85	1.97	2.09	
				2.07V	1.95	2.07	2.19	
				2.37V	2.25	2.37	2.49	
				2.57V	2.45	2.57	2.69	
				2.87V	2.75	2.87	2.99	V
				3.86V	3.73	3.86	3.99	
				4.35V	4.21	4.35	4.49	
Detection voltage unknown state	POUKS		• See Fig. 6. (Note 7-2)			0.7	0.95	
Power supply rise time	PORIS		<ul> <li>Power supply rise time from 0V to 1.6V.</li> </ul>				100	ms

Note7-1: The POR release level can be selected out of 8 levels only when the LVD reset function is disabled. Note7-2: POR is in an unknown state before transistors start operation.

#### Low Voltage Detection Reset (LVD) Characteristics at $Ta = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{SS}1=0V$

						Specific	ation	
Parameter	Symbol	Pin/Remarks	Conditions	Option selected voltage	min	typ	max	unit
LVD reset voltage	LVDET		Select from option.	1.91V	1.81	1.91	2.01	
(Note 8-2)			(Note 8-1)	2.01V	1.91	2.01	2.11	
			(Note 8-3) • See Fig. 7.	2.31V	2.21	2.31	2.41	
			• See Fig. 7.	2.51V	2.41	2.51	2.61	V
				2.81V	2.71	2.81	2.91	
				3.79V	3.69	3.79	3.89	
				4.28V	4.18	4.28	4.38	
LVD hysteresys	LVHYS			1.91V		55		
width				2.01V		55		
				2.31V		55		
				2.51V		55		mV
				2.81V		60		
				3.79V		65		
				4.28V		65		
Detection voltage unknown state	LVUKS		• See Fig. 7. (Note 8-4)			0.7	0.95	V
Low voltage detection minimum width (Reply sensitivity)	TLVDW		• LVDET-0.5V • See Fig. 8.		0.2			ms

Note8-1: The LVD reset level can be selected out of 7 levels only when the LVD reset function is enabled.

Note8-2: LVD reset voltage specification values do not include hysteresis voltage.

Note8-3: LVD reset voltage may exceed its specification values when port output state changes and/or when a large current flows through port.

Note8-4: LVD is in an unknown state before transistors start operation.

Demonster	O week al	Pin/	Que distance			Specifi	cation	
Parameter	Symbol	Remarks	Conditions	V <sub>DD</sub> [V]	min	typ	max	unit
Input common-	VCMIN	P12(CMP1IA),						
mode voltage		P11(CMP1IB),		2.8 to 5.5	V		V <sub>DD</sub>	v
(Note9-1)		P17(CMP2IA),		2.8 10 5.5	VSS		-1.5V	v
		P16(CMP2IB)						
Offset voltage	VCPOFF(1)	P12(CMP1IA),	Input common-mode voltage range					
		P11(CMP1IB),	CMP1 minus input					
		P17(CMP2IA),	= CMP1IA	2.8 to 5.5			±20	mV
		P16(CMP2IB)	CMP2 minus input					
			= CMP2IA					
	VCPOFF(2)	P12(CMP1IA),	<ul> <li>Input common-mode voltage range</li> </ul>					
		P11(CMP1IB),	CMP1 minus input					
		P17(CMP2IA),	= CMP1vref (Note9-2)	2.8 to 5.5			±40	mV
		P16(CMP2IB)	CMP2 minus input					
			= CMP2 vref (Note9-2)					
CMP	tCRT	P13(CMP1O),	<ul> <li>Input common-mode voltage range</li> </ul>					
response		P15(CMP2O)	<ul> <li>Input amplitude=100mV,</li> </ul>					
speed			Over drive=50mV					
			CMP1 minus input	2.8 to 5.5		200		ns
			= CMP1IA					
			CMP2 minus input					
			= CMP2IA					

## **Comparator Characteristics** at Ta = -40 °C to +85 °C, $V_{SS}1 = 0V$

Note9-1: When VDD=5V, input voltage is effective from 0 to 3.5V.

Note9-2:

Rang1: CMP1vref1= (CMP1vref-Register<3:0> + 1)/16 ×  $V_{DD}$  × 0.64

CMP2vref2= (CMP2vref-Register<3:0> + 1)/16 ×  $V_{DD} \times 0.64$ 

Rang2: CMP1vref1= (CMP1vref-Register<3:0>+1)/64 ×  $V_{DD}$  × 0.64

 $CMP2vref2=(CMP2vref-Register<3:0>+1)/64\times V_{DD}\times 0.64$ 

\*: Range1/Range2 setting by a register is common to comparators 1 and 2.

#### Consumption Current Characteristics at Ta = -40 °C to +85 °C, $V_{SS}1 = 0$ V

Devenueter	Querra ha a l	Pin/	Que ditione			Specifi	cation	
Parameter	Symbol	Remarks	Conditions	V <sub>DD</sub> [V]	min	typ	max	unit
Normal mode consumption current (Note 10-1) (Note 10-2)	IDDOP(1)	V <sub>DD</sub> 1	<ul> <li>Internal Medium speed RC oscillation stopped.</li> <li>System clock set to internal High speed RC oscillation(10MHz).</li> <li>1/1 frequency division ratio</li> </ul>	2.8 to 5.5		3.4	4.8	mA
	IDDOP(2)		<ul> <li>Internal High speed RC oscillation stopped.</li> <li>System clock set to internal Medium speed RC oscillation.</li> <li>1/2 frequency division ratio</li> </ul>	2.8 to 5.5		0.2	0.4	
HALT mode consumption current (Note 10-1) (Note 10-2)	IDDHALT(1)	V <sub>DD</sub> 1	<ul> <li>HALT mode</li> <li>Internal Medium speed RC oscillation stopped.</li> <li>System clock set to internal High speed RC oscillation(10MHz).</li> <li>1/1 frequency division ratio</li> </ul>	2.8 to 5.5		1.6	2.3	mA
	IDDHALT(2)	V <sub>DD</sub> 1	<ul> <li>HALT mode</li> <li>Internal High speed RC oscillation stopped.</li> <li>System clock set to internal Medium speed RC oscillation.</li> <li>1/2 frequency division ratio</li> </ul>	2.8 to 5.5		0.10	0.19	
HOLD mode consumption current	IDDHOLD(1)	V <sub>DD</sub> 1	HOLD mode	2.8 to 5.5		0.03	32	
(Note 10-1) (Note 10-2) (Note 10-3)	IDDHOLD(2)		HOLD mode • LVD option selected	2.8 to 5.5		3	35	μA

Note10-1: Values of the consumption current do not include current that flows into the output transistors and internal pull-up resistors.

Note10-2: The consumption current values do not include operational current of LVD function if not specified. Note10-3: The amplifier / comparator circuit operates in the HOLD mode.

## **F-ROM Programming Characteristics** at $Ta = +10^{\circ}C$ to $+55^{\circ}C$ , $V_{SS}1 = 0V$

Descenter	Ourseland.	Dia (Desas entre	Oranditions			Specifi	cation	ion	
Parameter	Symbol	Pin/Remarks	Conditions	V <sub>DD</sub> [V]	min	typ	max	unit	
Onboard	IDDFW(1)	V <sub>DD</sub> 1	<ul> <li>Only current of the Flash block.</li> </ul>						
programming				2.8 to 5.5		5	10	mA	
current									
Programming	tFW(1)		Erasing time	0.045.5.5		20	30	ms	
time	tFW(2)		Programming time	2.8 to 5.5		40	60	μS	



Figure 1 AC Timing Measurement Point







Note:

External circuits for reset may vary depending on the usage of POR and LVD. Please refer to the user's manual for more information.

Figure 3 Reset Circuit



Figure 4 Serial I/O Output Waveforms



Figure 5 Pulse Input Timing Signal Waveform



(RESET pin: Pull-up resistor R<sub>RES</sub> only)

- The POR function generates a reset only when power is turned on starting at the VSS level.
- No stable reset will be generated if power is turned on again when the power level does not go down to the VSS level as shown in (a). If such a case is anticipated, use the LVD function together with the POR function or implement an external reset circuit.
- A reset is generated only when the power level goes down to the VSS level as shown in (b) and power is turned on again after this condition continues for 100µs or longer.



(RESET pin: Pull-up resistor RRES only)

- Resets are generated both when power is turned on and when the power level lowers.
- A hysteresis width (LVHYS) is provided to prevent the repetitions of reset release and entry cycles near the detection level.



Figure 8 Low voltage detection minimum width (Example of momentary power loss/Voltage variation waveform)

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